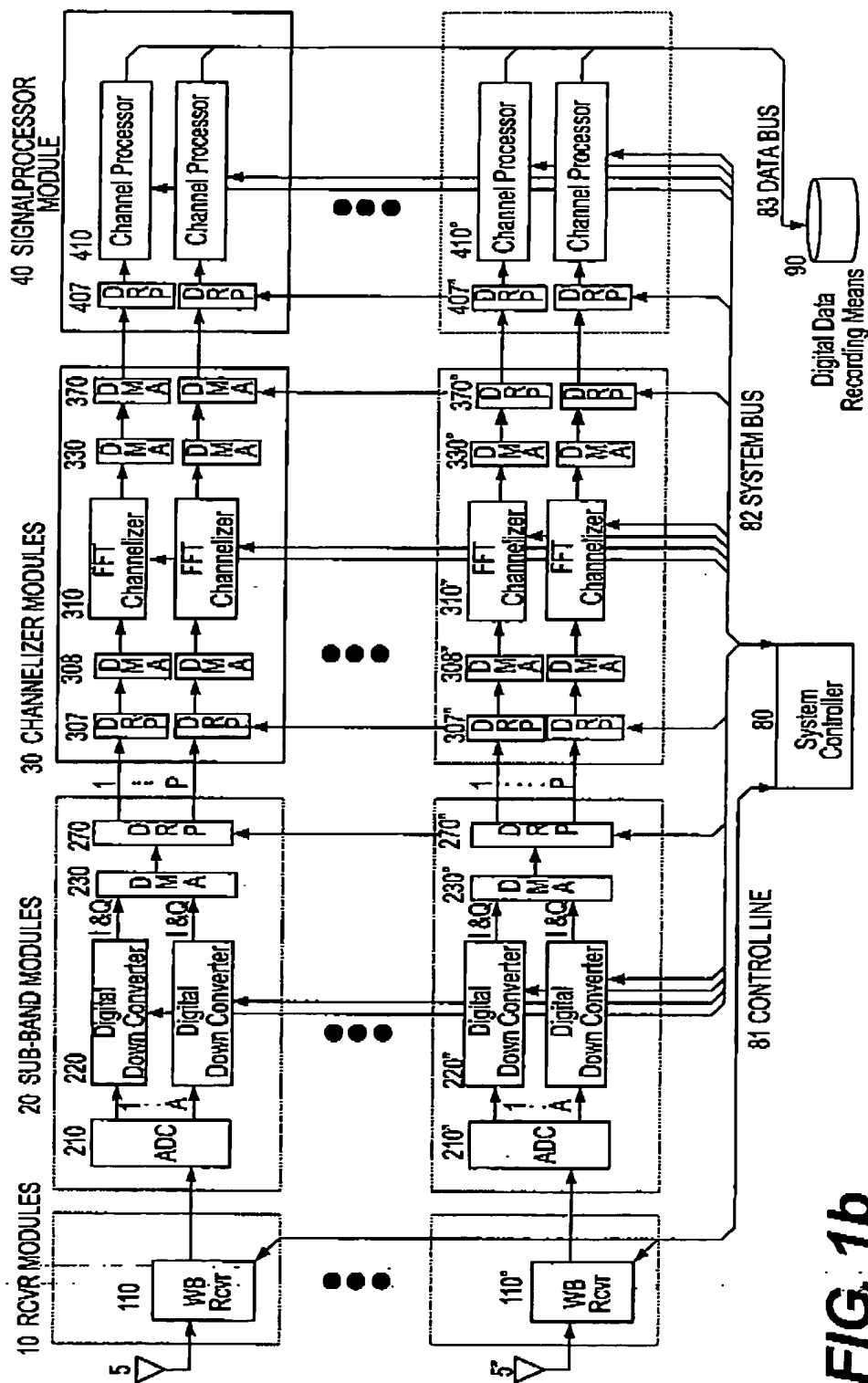
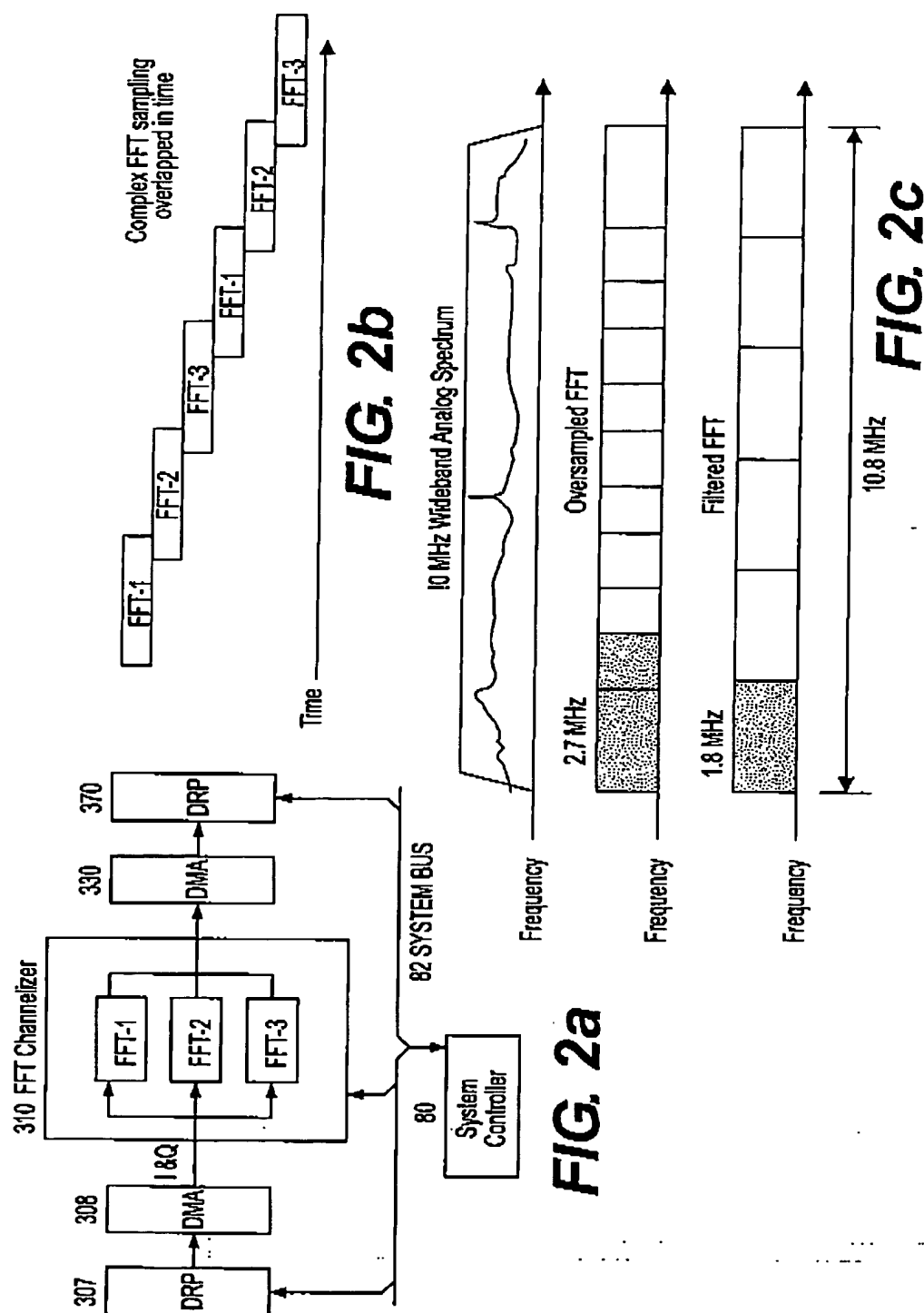
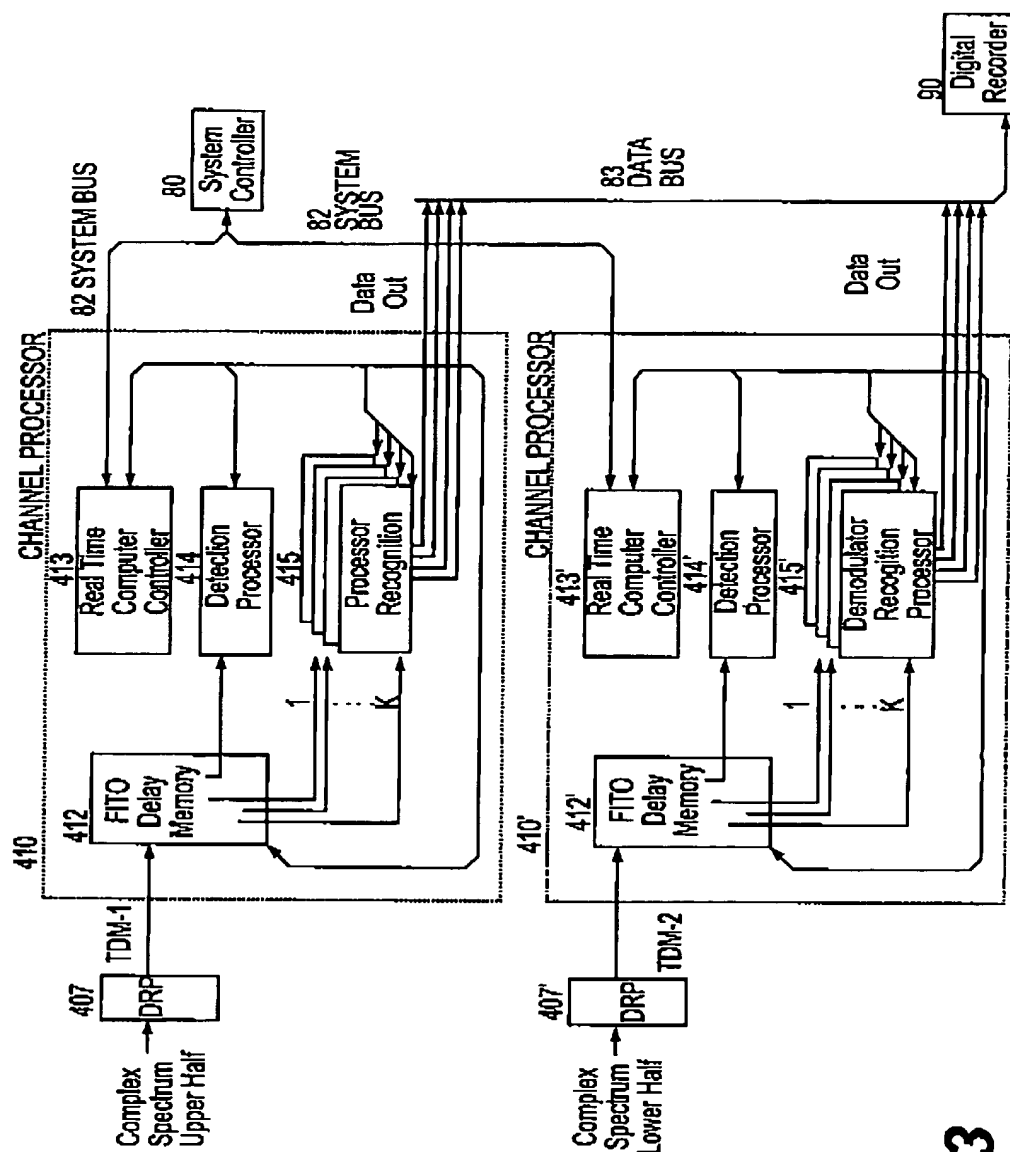
**FIG. 1a****RECEIVED**

MAR 30 2004

Technology Center 2600







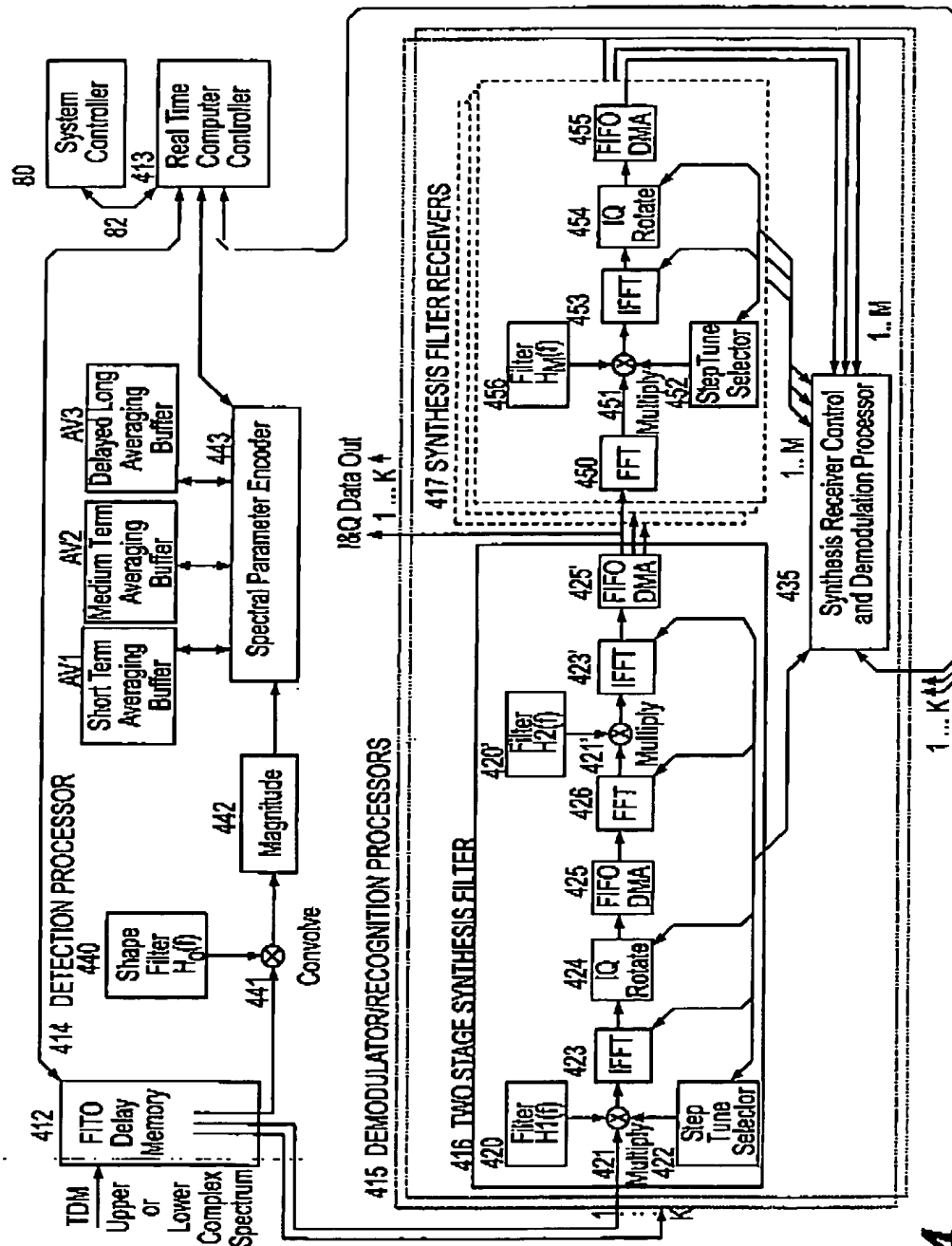


FIG. 4

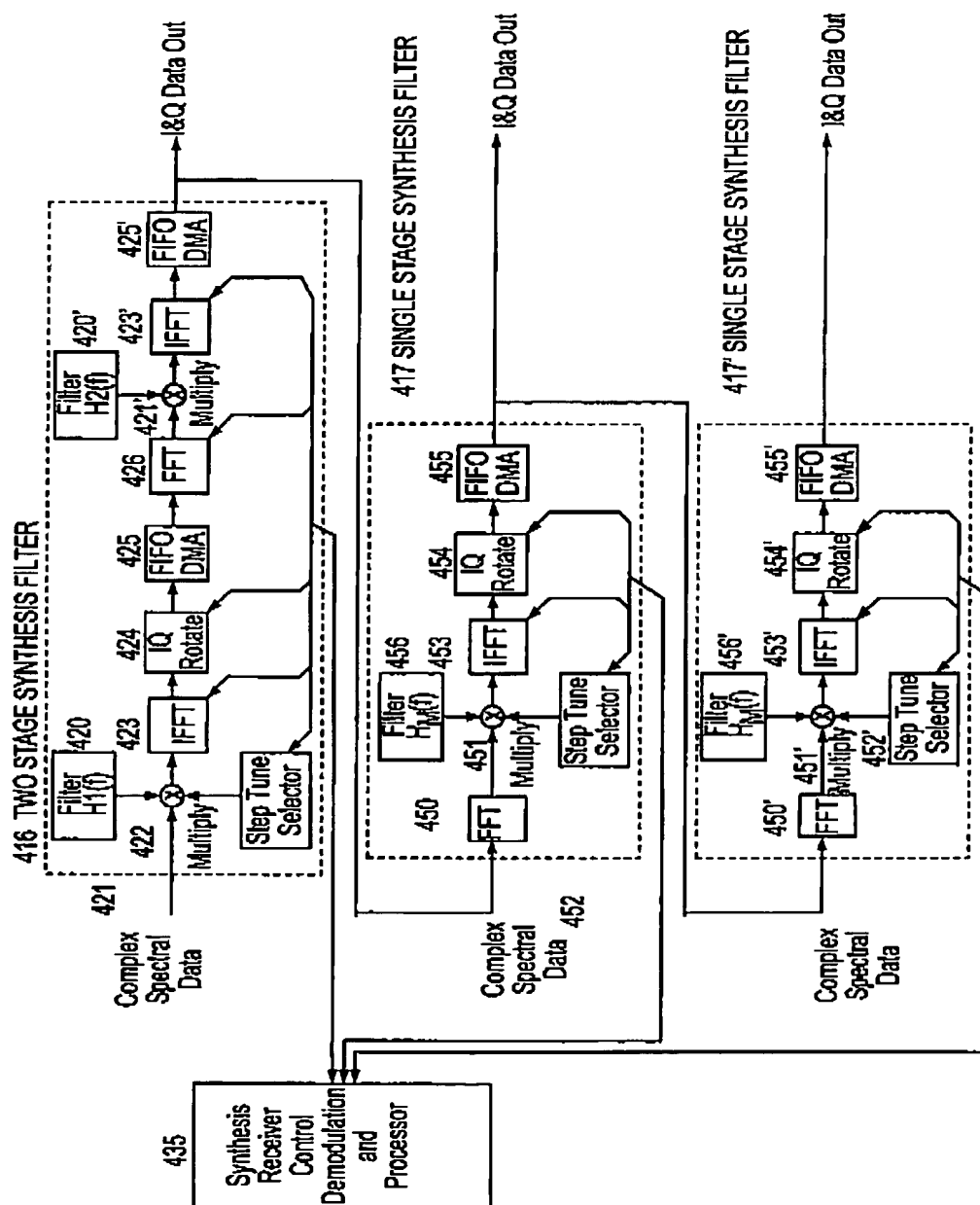
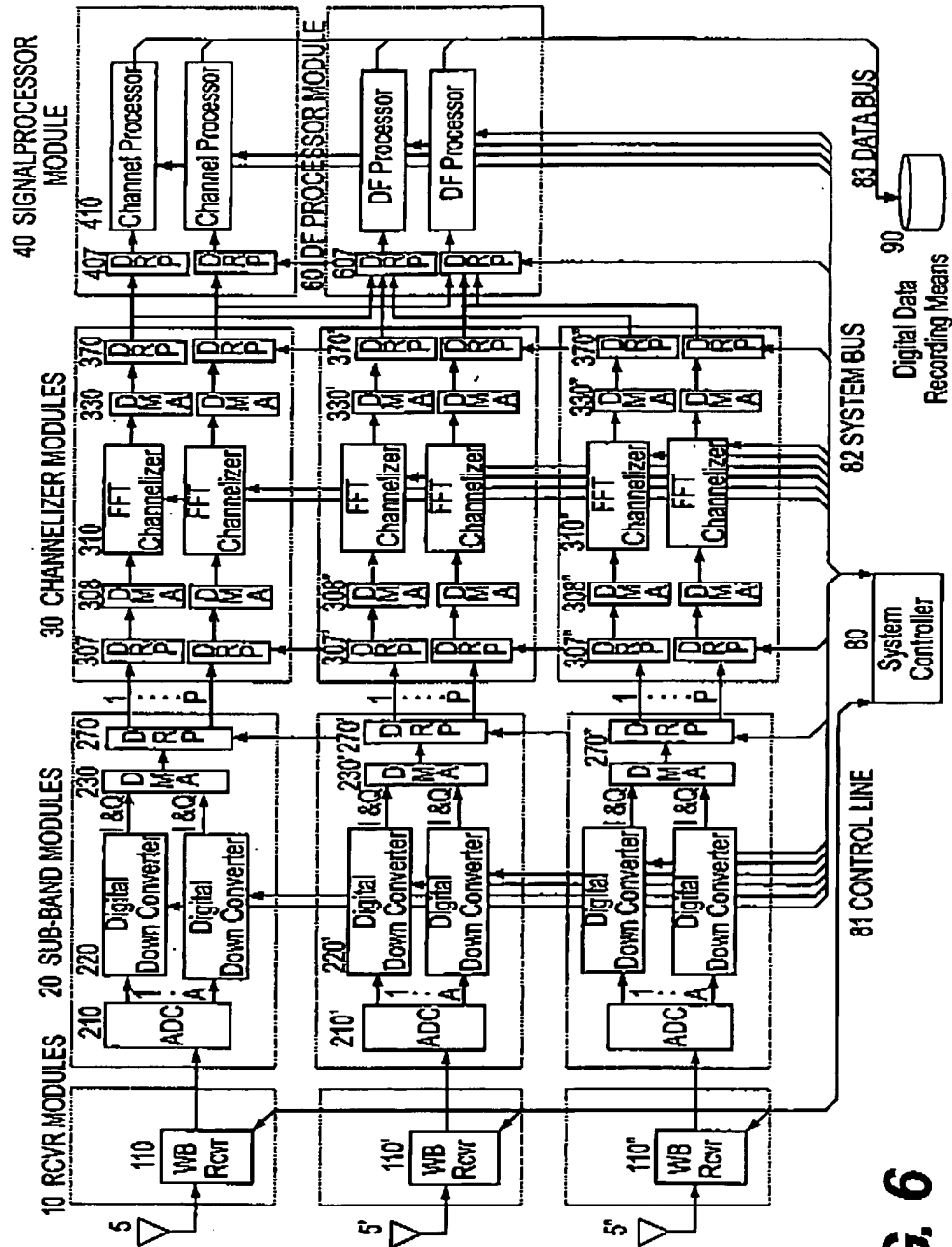
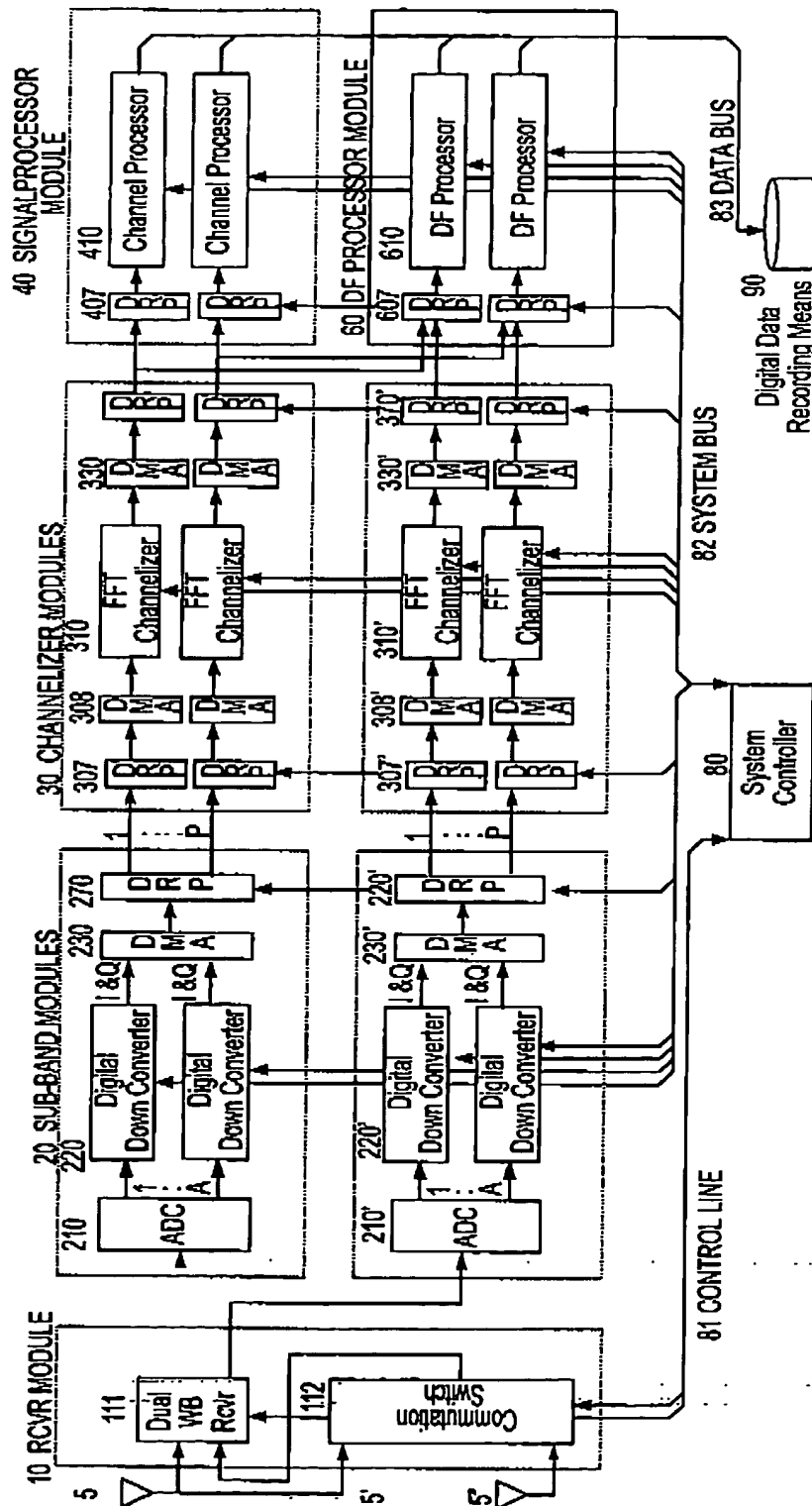
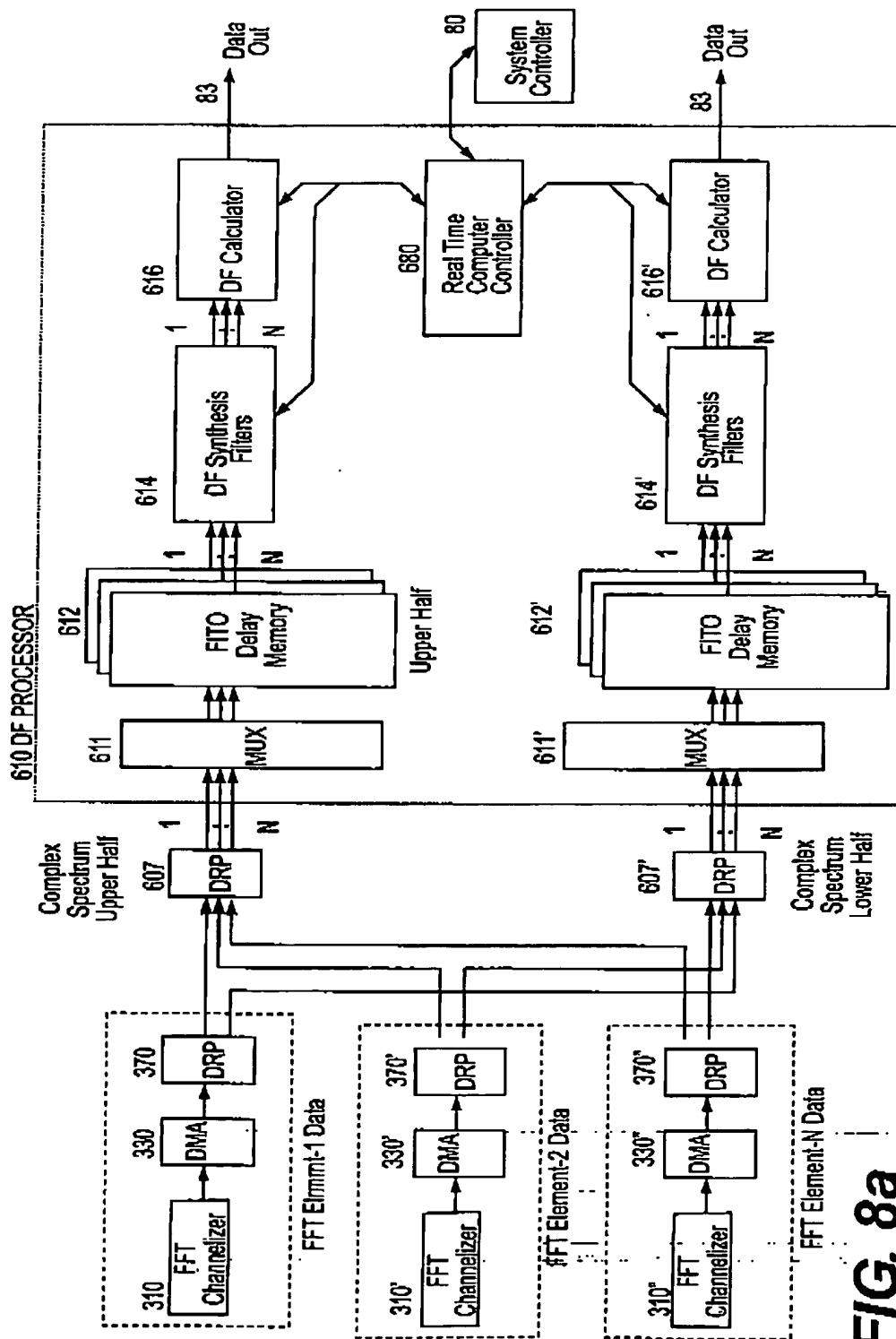
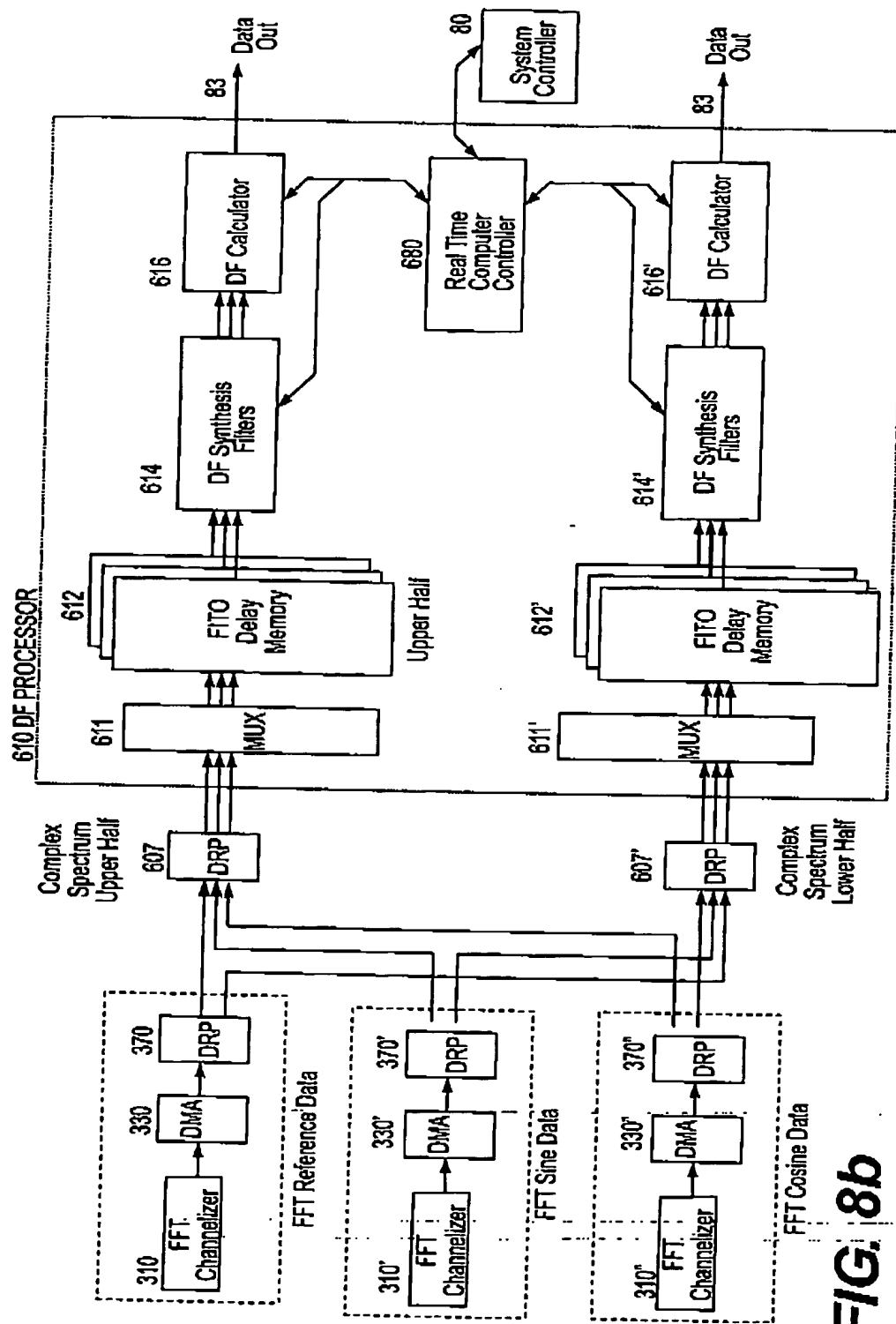


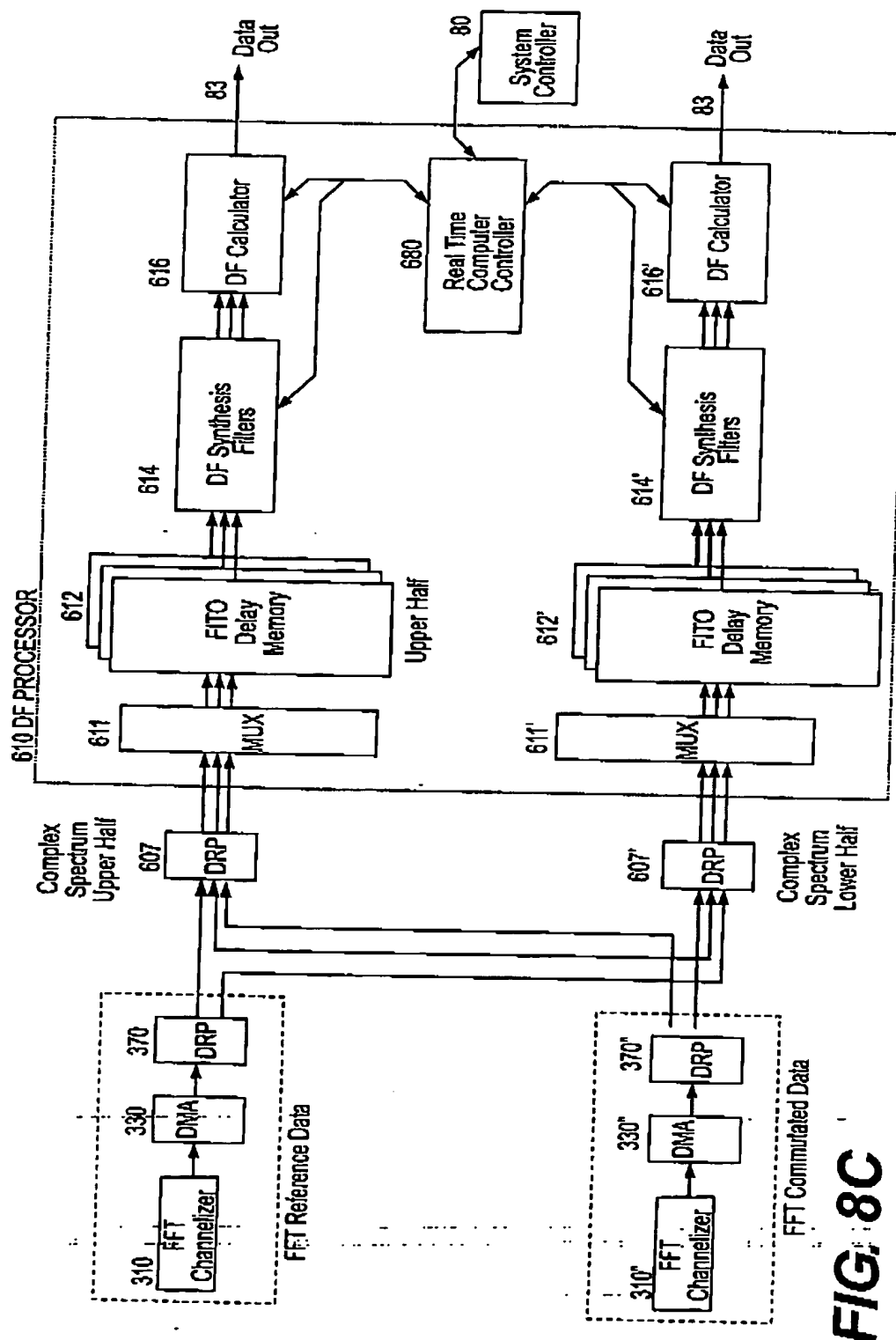
FIG. 5

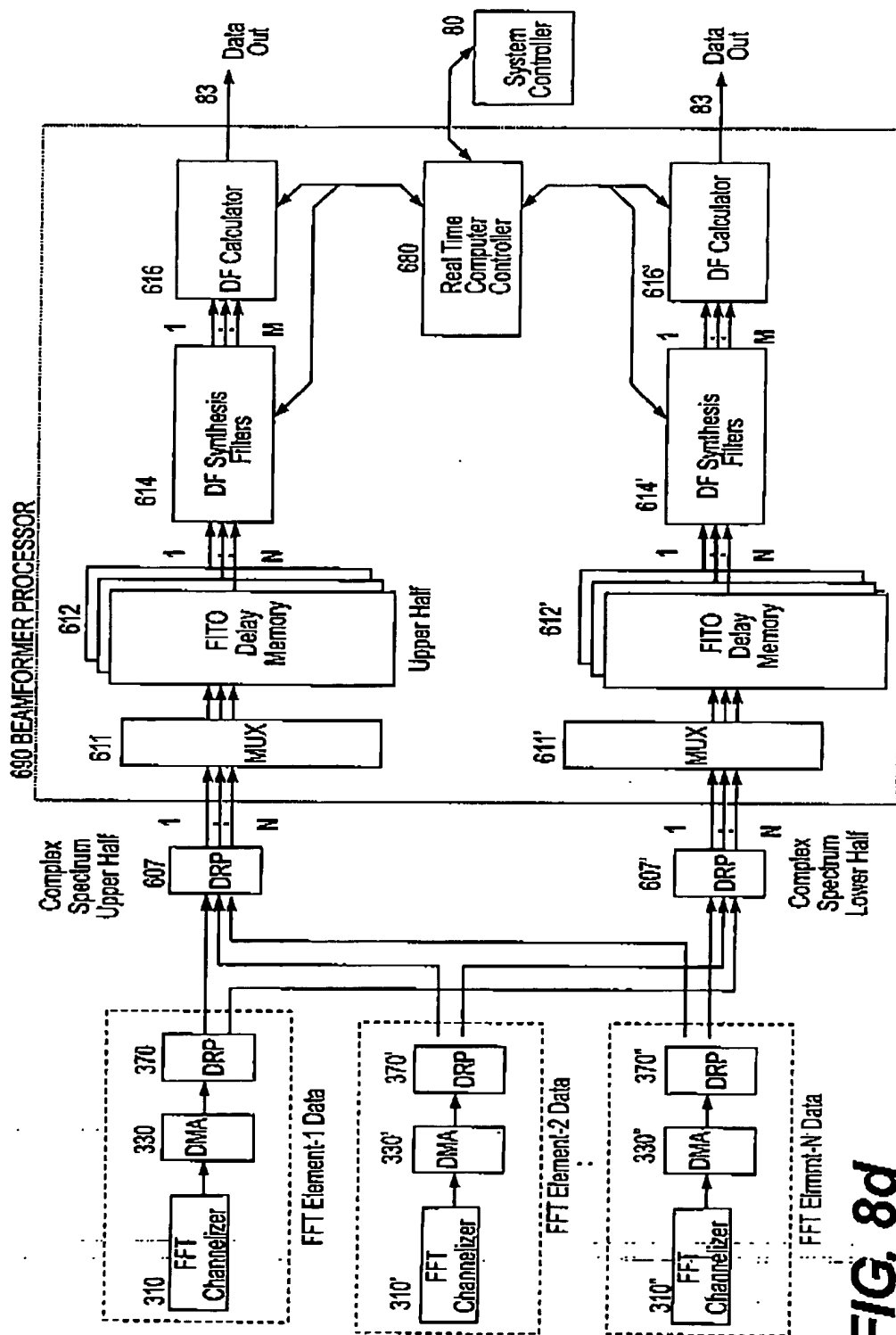
**FIG. 6**

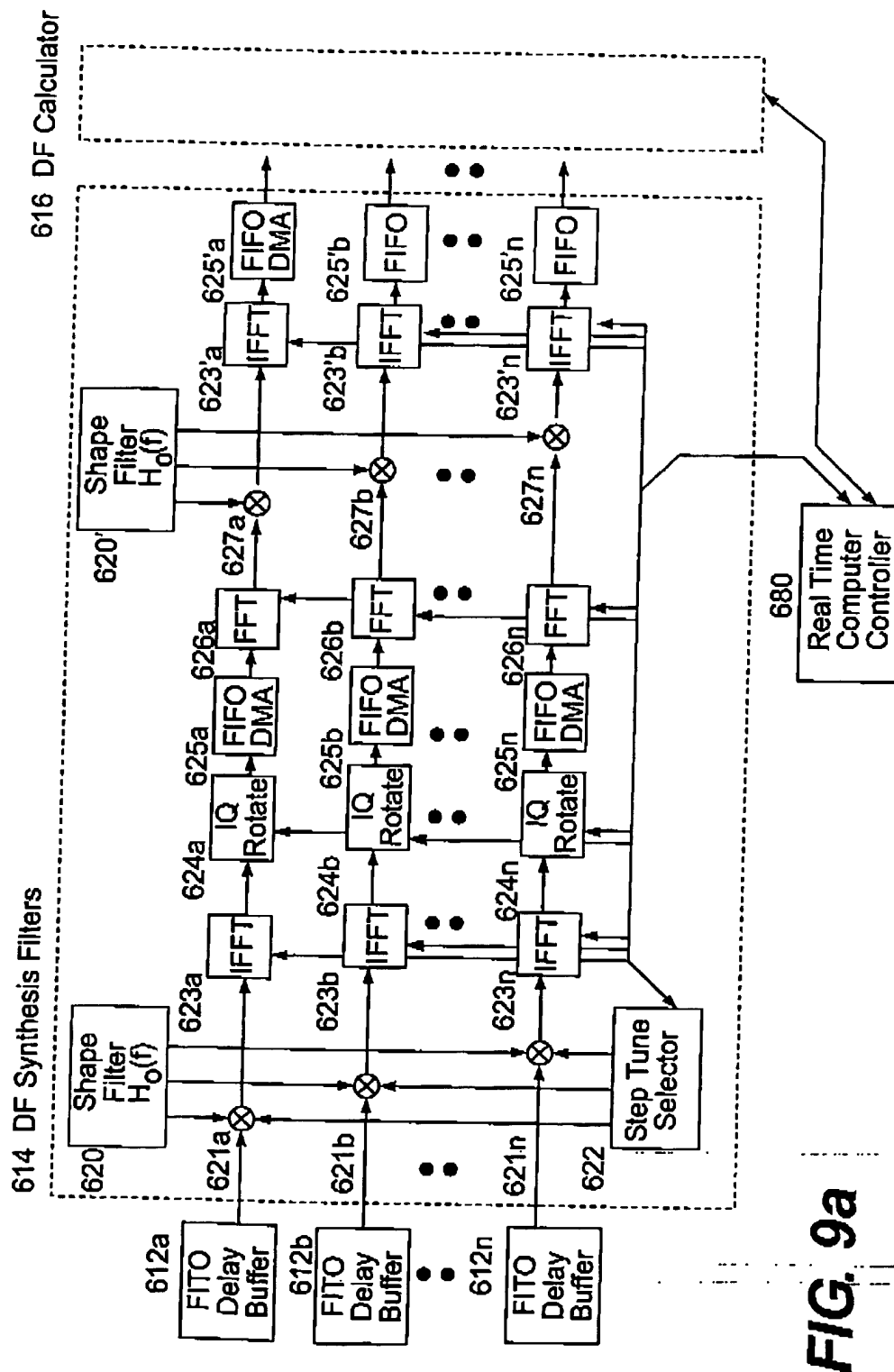
**FIG. 7**

**FIG. 8a**

**FIG. 8b**

**FIG. 8C**

**FIG. 8d**



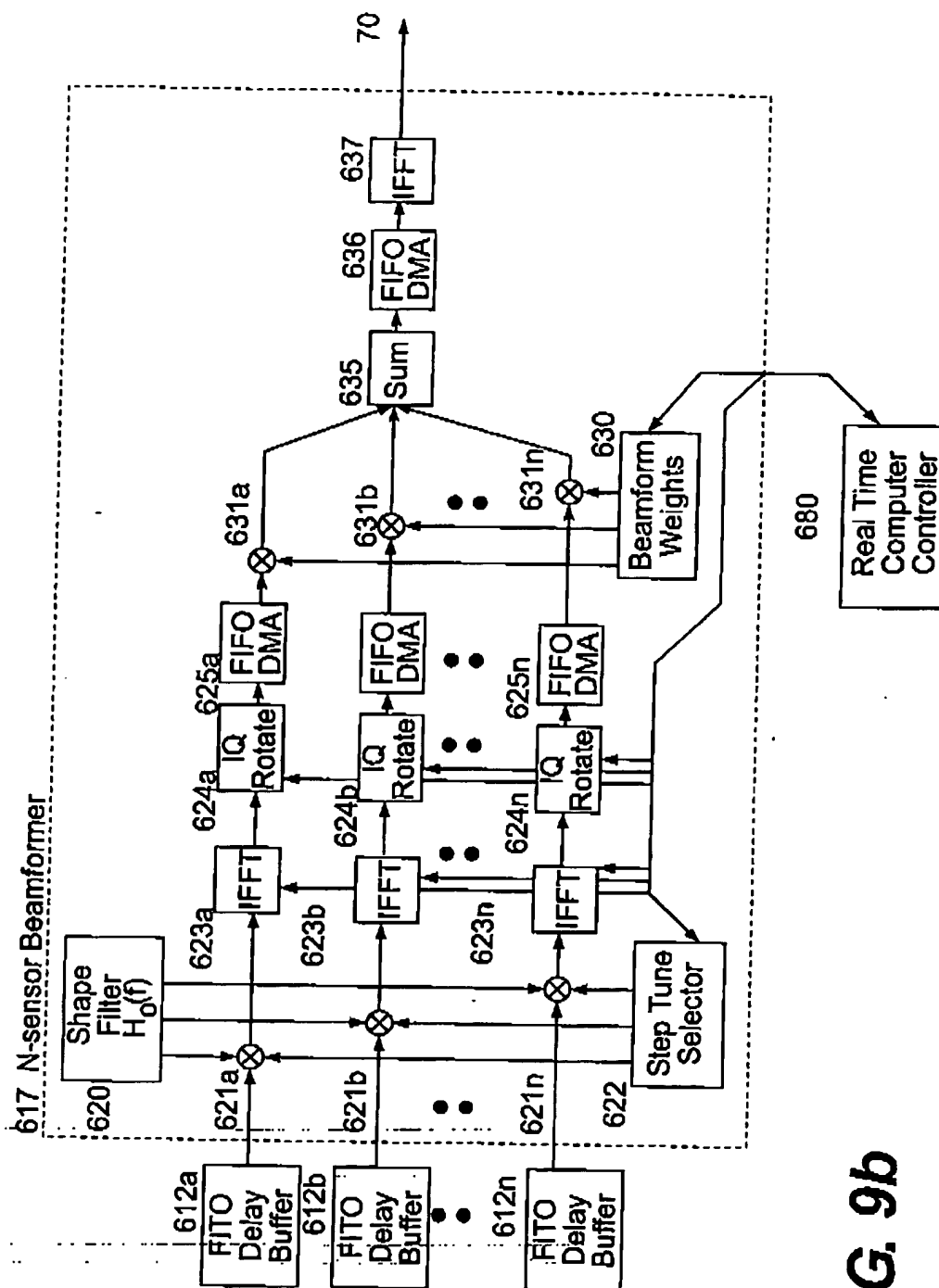
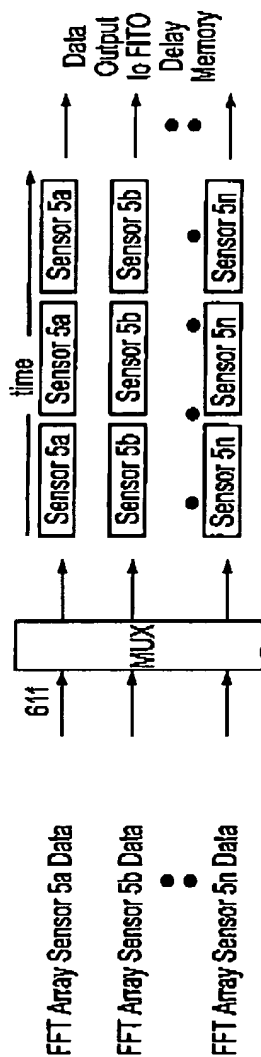
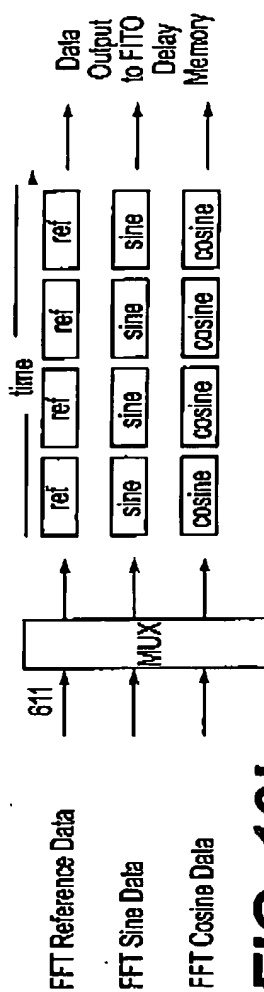
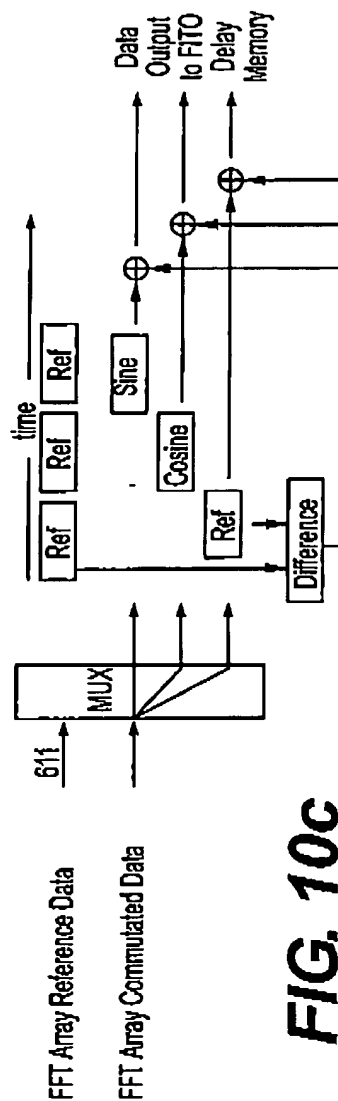
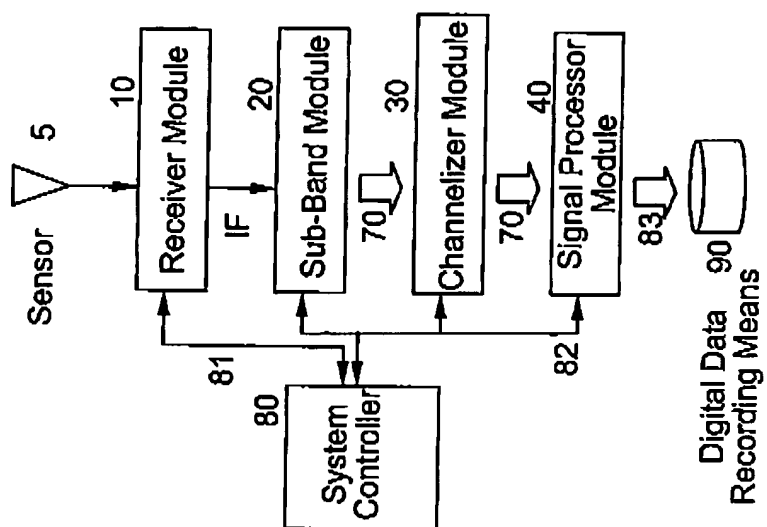
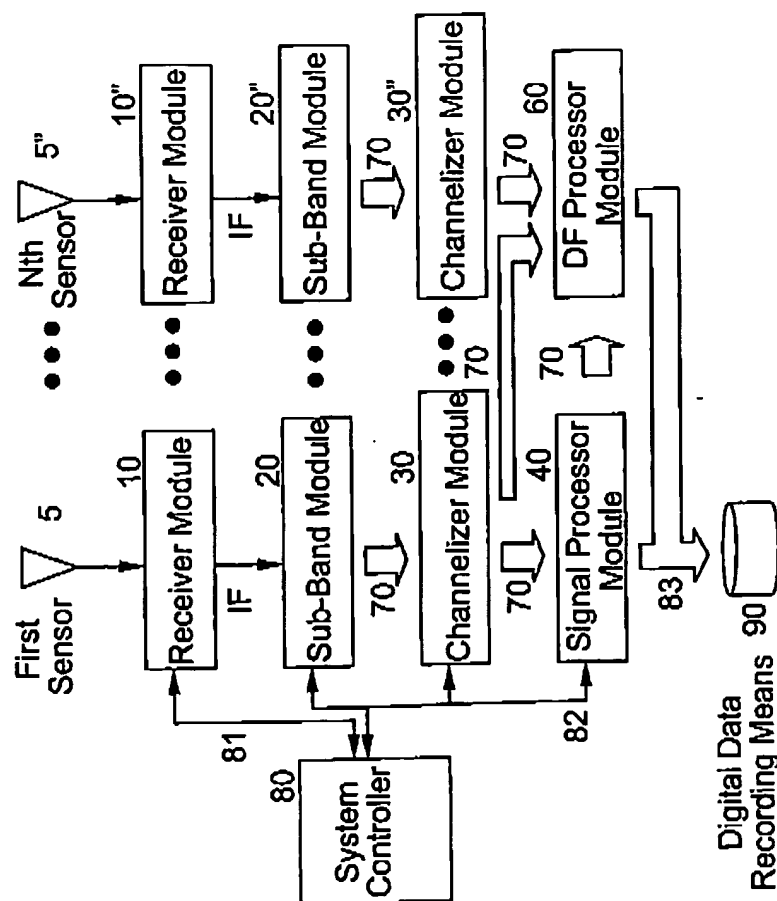
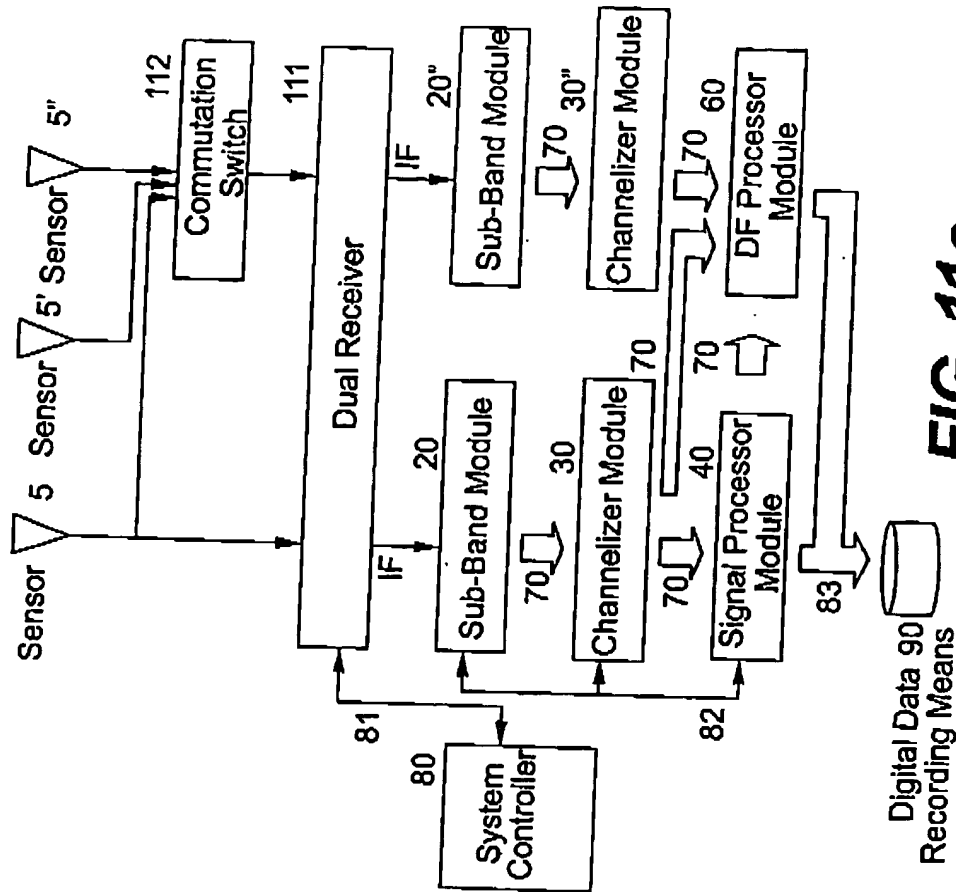


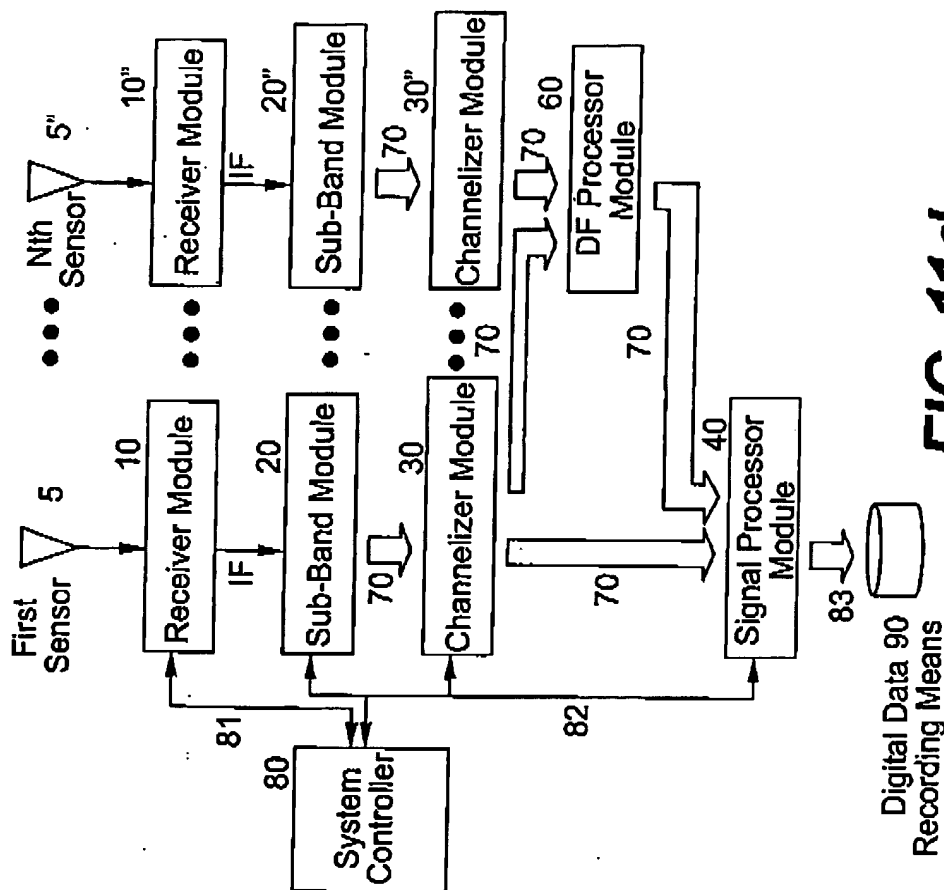
FIG. 9b

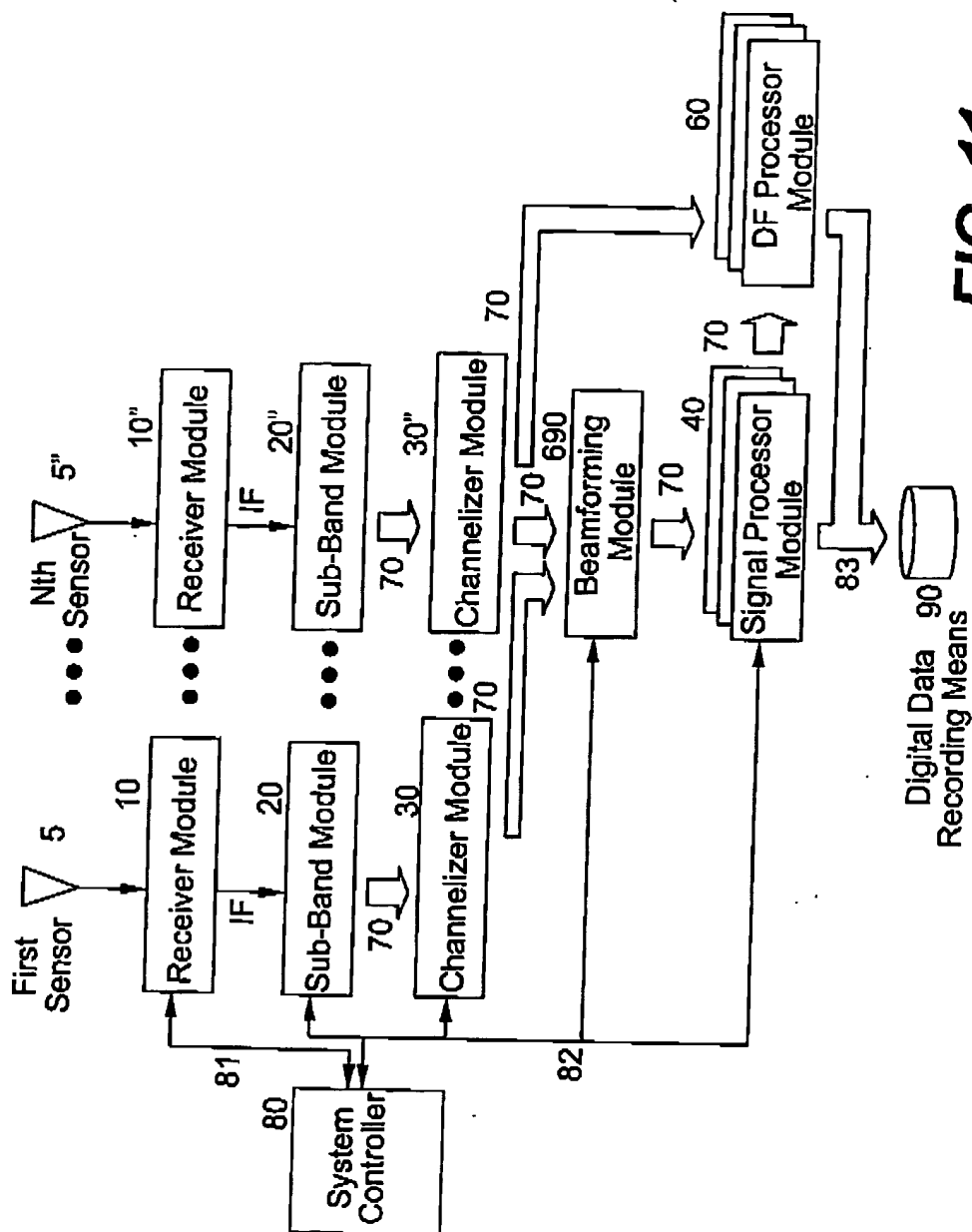
**FIG. 10a****FIG. 10b****FIG. 10c**

**FIG. 11a**

**FIG. 11b**

**FIG. 11c**

**FIG. 11d**

**FIG. 11e****RECEIVED**

MAR 30 2004

Technology Center 2600